TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC4049BP,TC4049BF,TC4049BFN, TC4050BP,TC4050BF,TC4050BFN

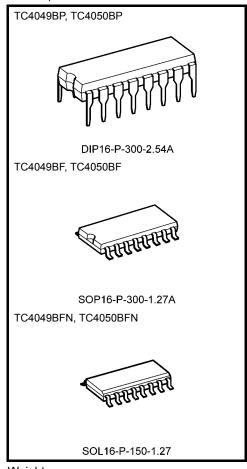
TC4049B Hex Buffer/Converter (inverting type)
TC4050B Hex Buffer/Converter (non-inverting type)

TC4049B, TC4050B contain six circuits of buffers. TC4049B is inverter type and TC4050B is non-inverter type.

Since one TTL or DTL can be directly driven having large output current, these are useful for interfacing from CMOS to TTL or DTL. As voltage up to VSS + 18 volts can be applied to the input regardless of VDD, these can be also used as the level converter IC's which converts CMOS logical circuits of 15 volts or 10 volts system to CMOS/TTL logical circuits of 5 volts system.

Ideal switching characteristic has been obtained by the circuit diagram of three stage inverters for TC4049B and two stage inverters for TC4050B.

Note: xxxFN (JEDEC SOP) is not available in Japan.

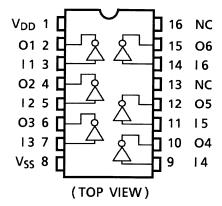


Weight

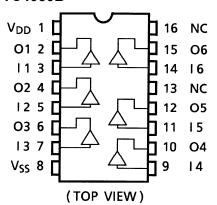
DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.) SOL16-P-150-1.27 : 0.13 g (typ.)

Pin Assignment

TC4049B

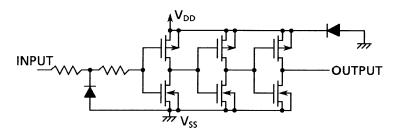


TC4050B

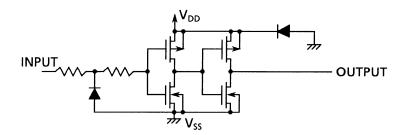


Circuit Diagram

1/6 TC4049B



1/6 TC4050B



Absolute Maximum Ratings (Note)

			1
Characteristics	Symbol	Rating	Unit
DC supply voltage	V_{DD}	V _{SS} - 0.5~V _{SS} + 20	V
Input voltage	V _{IN}	V _{SS} - 0.5~V _{SS} + 20	V
Output voltage	V _{OUT}	V _{SS} - 0.5~V _{DD} + 0.5	V
DC input current	I _{IN}	±10	mA
Power dissipation	PD	300 (DIP)/180 (SOIC)	mW
Operating temperature range	T _{opr}	-40~85	°C
Storage temperature range	T _{stq}	−65~150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Operating Ranges (V_{SS} = 0 V) (Note)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
DC supply voltage	V_{DD}	_	3	_	18	V
Input voltage	V _{IN}	_	0		18	V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{DD} or V_{SS} .

Static Electrical Characteristics (V_{SS} = 0 V)

Characteristics		Sym-	Test Condition		-40°C		25°C		85°C		l lmit		
		bol		V _{DD} (V)	Min	Max	Min	Тур.	Max	Min	Max	Unit	
High-level output voltage			I _{OUT} < 1 μA	5	4.95		4.95	5.00	_	4.95	_		
		V_{OH}	$V_{IN} = V_{SS}, V_{DD}$	10	9.95	_	9.95	10.00	_	9.95	_	V	
			VIIV — VSS, VDD	15	14.95	_	14.95	15.00	_	14.95	_		
			 I _{OUT} < 1 μA	5	_	0.05	_	0.00	0.05	_	0.05		
Low-level of voltage	output	V_{OL}	$V_{IN} = V_{SS}, V_{DD}$	10	_	0.05	_	0.00	0.05	_	0.05	V	
			VIIV — VSS, VDD	15	_	0.05		0.00	0.05	_	0.05		
			V _{OH} = 4.6 V	5	-0.73	_	-0.65	-1.2	_	-0.58	_		
			V _{OH} = 2.5 V	5	-2.40	_	-2.10	-3.9	_	-1.90	_		
Output hig	h current	I _{OH}	V _{OH} = 9.5 V	10	-1.80	_	-1.65	-2.5	_	-1.35	_	mA	
			V _{OH} = 13.5 V	15	-4.80	_	-4.30	-8.0	_	-3.50	_		
			$V_{IN} = V_{SS}, V_{DD}$										
			V _{OL} = 0.4 V	5	3.8	_	3.2	6.4	_	2.9	_	mA	
Output low	, ourront		V _{OL} = 0.5 V	10	9.6	_	8.0	16.0	_	6.6	_		
Output low current		loL	V _{OL} = 1.5 V	15	28.0	_	24.0	48.0	_	20.0	_	IIIA	
			$V_{IN} = V_{SS}, V_{DD}$										
		V _{IH}	V _{OUT} = 0.5 V, 4.5 V	5	3.5	_	3.5	2.75	_	3.5	_		
Innut bigh	voltage		V _{OUT} = 1.0 V, 9.0 V	10	7.0	_	7.0	5.50	_	7.0	_		
Input high	voitage		V _{OUT} = 1.5 V, 13.5 V	15	11.0	_	11.0	8.25	_	11.0	_	V	
			I _{OUT} < 1 μA										
			V _{OUT} = 0.5 V, 4.5 V	5	_	1.5	_	2.25	1.5	_	1.5		
Input low voltage		V _{IL}	V _{OUT} = 1.0 V, 9.0 V	10	_	3.0	_	4.50	3.0	_	3.0	V	
			V _{OUT} = 1.5 V, 13.5 V	15	_	4.0	_	6.75	4.0	_	4.0		
			$ I_{OUT} < 1 \mu A$										
Input current	"H" level	I _{IH}	V _{IH} = 18 V	18	_	0.1	_	10 ⁻⁵	0.1	_	1.0		
	"L" level	Ι _Ι L	V _{IL} = 0 V	18	_	-0.1	_	-10 ⁻⁵	-0.1	_	-1.0	μΑ	
				5	_	1	_	0.002	1	_	30		
Quiescent supply current		I _{DD}	$V_{IN} = V_{SS}, V_{DD}$	10	_	2	_	0.004	2	_	60	μА	
			(Note)	15	_	4	_	0.008	4	_	120		

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Note: All valid input combinations.

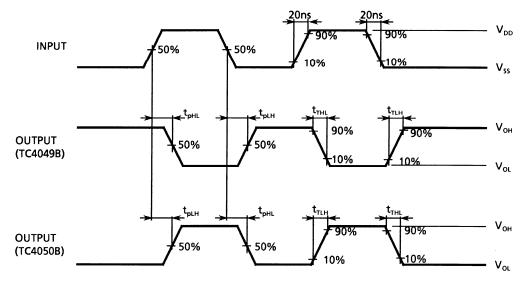


Dynamic Electrical Characteristics (Ta = 25°C, V_{SS} = 0 V, C_L = 50 pF)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
		Symbol		V _{DD} (V)	IVIIII	ιyp.	IVIAX	Offic
Output transition time				5	_	60	160	
	to high)	t _{TLH}	_	10	_	30	80	ns
(IOW	to riigir)			15	_	25	60	
Outr	out transition time			5	_	120	60	
	n to low)	t _{THL}	_	10	_	10	40	ns
(High	T to low)			15	_	8	30	
	Propagation delay time (low to high)			5	_	60	120	
TC4049B		^t pLH	_	10	_	35	65	ns
				15	_	30	50	
104	Propagation delay time (high to low)			5	_	40	60	
		t _{pHL}	_	10	_	20	30	ns
				15	_	15	20	
	Propagation delay time (low to high)			5	_	50	130	
TC4050B		t _{pLH}	_	10	_	30	70	ns
				15	_	25	55	
	Propagation delay time (high to low)			5	_	30	70	
		t _{pHL}	_	10	_	17	35	ns
	(High to low)			15		14	25	
Inpu	t capacitance	C _{IN}			_	5	7.5	pF

Waveform for Measurement of Dynamic Characteristics

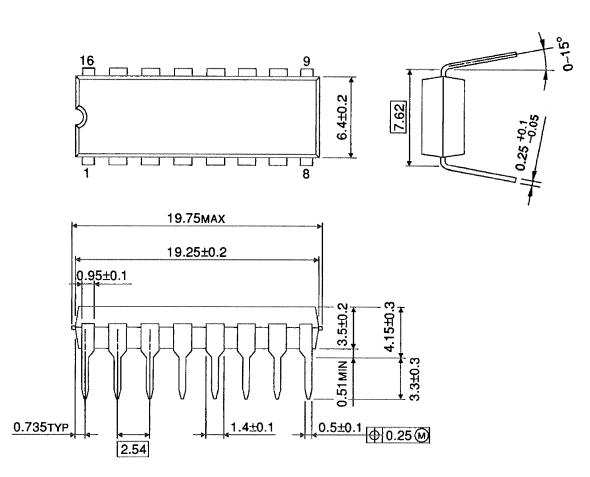
Waveform





Package Dimensions

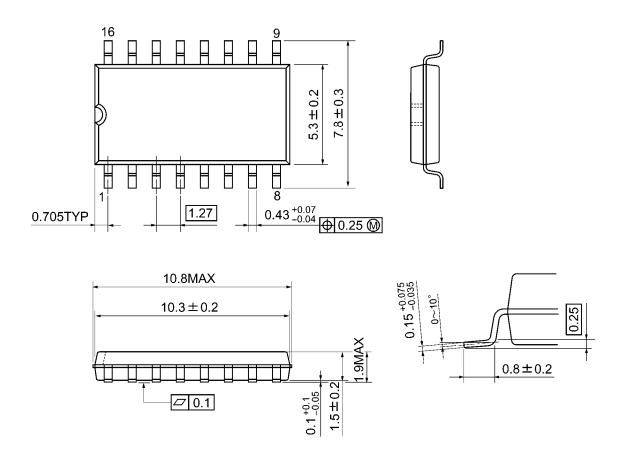
DIP16-P-300-2.54A Unit: mm



Weight: 1.00 g (typ.)

Package Dimensions

SOP16-P-300-1.27A Unit: mm



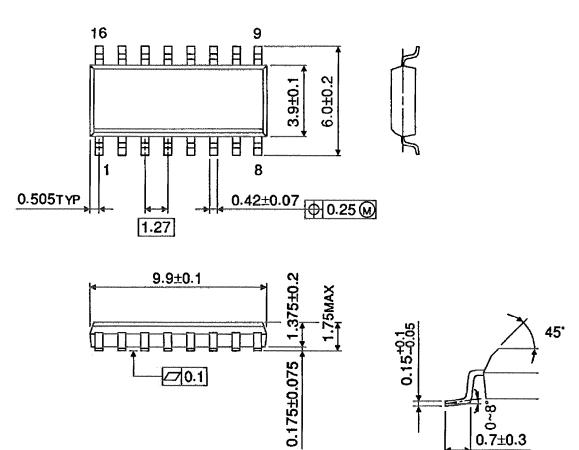
6

Weight: 0.18 g (typ.)



Package Dimensions (Note)

SOL16-P-150-1.27 Unit: mm



Note: This package is not available in Japan.

Weight: 0.13 g (typ.)



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